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ATTORNEY DOCKET NO. APPLICATION NO. **FILING DATE** CONFIRMATION NO. FIRST NAMED INVENTOR 10/649,746 08/28/2003 Fukashi Harada 031071 5719 23850 05/03/2004 7590 **EXAMINER** ARMSTRONG, KRATZ, QUINTOS, HANSON & BROOKS, LLP NADAV, ORI 1725 K STREET, NW **SUITE 1000 ART UNIT** PAPER NUMBER WASHINGTON, DC 20006 2811

DATE MAILED: 05/03/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

Application No. 10/649,746	Applicant(s)	/
10.0.0,7.10	HARADA ET AL.	Ø
Examiner	Art Unit	
ori nadav	2811	
		dress
Period for Reply		
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).		
gust 2003.		
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is		
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.		
4)⊠ Claim(s) <u>1-22</u> is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration.		
5) Claim(s) is/are allowed.		
6)⊠ Claim(s) <u>1-22</u> is/are rejected.		
7) Claim(s) is/are objected to.		
election requirement.		
•		
10)⊠ The drawing(s) filed on <u>28 August 2003</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.		
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).		
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).		
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.		
have been received. have been received in Application ty documents have been receive (PCT Rule 17.2(a)).	on No d in this National	Stage
4) Interview Summary (Paper No(s)/Mail Da	(PTO-413) te	- 152)
	ears on the cover sheet with the cars of the cars of the cars of the cover sheet with the cars of the car	ears on the cover sheet with the correspondence and sears on the cover sheet with the correspondence and sears on the cover sheet with the correspondence and sears on the cover sheet with the correspondence and sears on the cover, may a reply be timely filed within the statutory minimum of thirty (30) days will be considered timely apply and will expire SIX (6) MONTHS from the mailing date of this course the application to become ABANDONED (35 U.S.C. § 133), date of this communication, even if timely filed, may reduce any sequence of this communication, even if timely filed, may reduce any sequence except for formal matters, prosecution as to the exparte Quayle, 1935 C.D. 11, 453 O.G. 213. In from consideration. The consideration of the consideration of the examine traving(s) be held in abeyance. See 37 CFR 1.85(a), on is required if the drawing(s) is objected to. See 37 CF aminer. Note the attached Office Action or form PT priority under 35 U.S.C. § 119(a)-(d) or (f). The been received. The consideration of this National (PCT Rule 17.2(a)). The consideration of the certified copies not received. The consideration of the certified copies not received. The certified copies not received.

DETAILED ACTION

Priority

Receipt is acknowledged of papers submitted under 35 U.S.C. 119(a)-(d), which papers have been placed of record in the file.

Drawings

Figure 8 should be designated by a legend such as —Prior Art— because only that which is old is illustrated. See MPEP § 608.02(g). A proposed drawing correction or corrected drawings are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

Specification

The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

The disclosure is objected to because of the following informalities: The recitation of a "circle in figure 6" (see page 13) is not illustrated in figure 6.

Appropriate correction is required.

Claim Objections

Claims 1-7 are objected to because of the following informalities: The term "another in line 10 of claim 1, should read "other". Appropriate correction is required.

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Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 1-22 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. Applicant illustrates in figure 8 and describes in related text (pages 2 and 3) the disadvantages of a conventional device which includes forming a compound semiconductor film which contains silicon and another semiconductor element, and has a composition with a high content of silicon in an upper layer region and a lower layer region, and a high content of the other semiconductor element in an intermediate layer region. The present invention recites an intermediate layer region being the region which is formed on the side wall of opening 8 (page 10). The side wall of the opening 8 has a high content of silicon (page 13). Therefore, the intermediate layer region has a high content of silicon. Furthermore, the detailed description of the disclosure does not recite an intermediate layer region having a high content of the other semiconductor element. Therefore, there is no support in the detailed description of the disclosure for forming on an entire surface a compound semiconductor film which contains silicon and another semiconductor element, and has a composition with a high content of silicon in an upper layer region and a lower layer

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region, and a high content of the other semiconductor element in an intermediate layer region, as recited in claims 1 and 8.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-2, 4, 6, 8-9, 11-12, 14, 16-17, 19-20 and 22 are rejected under 35 U.S.C. 103(a) as being unpatentable over Asai et al. (6,713,790) in view of Applicant Admitted Prior Art (AAPA).

Regarding claims 1, 8 and 11, Asai et al. teach in figures 7-11 a manufacturing method of a semiconductor device which is formed with a bipolar transistor being composed by including a base, an emitter and a collector on a semiconductor substrate, comprising the steps of:

forming a multilayer film 115, 117, 120 on said semiconductor substrate 100, and forming an opening which is opened on said base and said emitter, in the multilayer film;

forming on an entire surface a compound semiconductor film 111 which contains silicon and another semiconductor element; and

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performing anisotropic dry etching (column 20, lines 19-27) for the compound semiconductor film so as to reach a certain height of the opening.

Note that the broad recitation of the claim does not require the compound semiconductor film to be anisotropic dry etched.

Asai et al. do not teach a compound semiconductor film having a composition with a high content of silicon in an upper layer region and a lower layer region, and a high content of the other semiconductor element in an intermediate layer region.

AAPA teaches in pages 2-3 that it is conventional to obtain a compound semiconductor film which contains silicon and another semiconductor element, and has a composition with a high content of silicon in an upper layer region and a lower layer region, and a high content of the other semiconductor element in an intermediate layer region. It would have been obvious to a person of ordinary skill in the art at the time the invention was made to use a compound semiconductor film having a composition with a high content of silicon in an upper layer region and a lower layer region, and a high content of the other semiconductor element in an intermediate layer region in Asai et al.'s device in order to simplify the processing steps of making the device by using a conventional processing method.

Regarding claims 2 and 9, Asai et al. teach using a high vacuum (column 3, lines 56-57). It would have been obvious to a person of ordinary skill in the art at the time the invention was made to use an anisotropic dry etching in a high vacuum in Asai et al.'s device in order to obtain better etching performance.

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Regarding claims 4, 6, 12 and 14, Asai et al. do not teach the atmospheric pressure in the high vacuum state is lower than 66.5 Pa and about 0.33 Pa. It would have been obvious to a person of ordinary skill in the art at the time the invention was made to use an atmospheric pressure in the high vacuum state of Asai et al.'s device to be lower than 66.5 Pa and about 0.33 Pa in order to obtain proper etching conditions.

Regarding claims 16-17, 19-20 and 22, Asai et al. teach the compound semiconductor film comprises an SiGe film or an SiGeC film.

Papers related to this application may be submitted to Technology center (TC) 2800 by facsimile transmission. Papers should be faxed to TC 2800 via the TC 2800 Fax center located in Crystal Plaza 4, room 4-C23. The faxing of such papers must conform with the notice published in the Official Gazette, 1096 OG 30 (November 15, 1989). The Group 2811 Fax Center number is (703) 308-7722 and 308-7724. The Group 2811 Fax Center is to be used only for papers related to Group 2811 applications.

Any inquiry concerning this communication or any earlier communication from the Examiner should be directed to *Examiner Nadav* whose telephone number is **(571) 272-1660**. The Examiner is in the Office generally between the hours of 7 AM to 4 PM (Eastern Standard Time) Monday through Friday.

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Any inquiry of a general nature or relating to the status of this application should be directed to the **Technology Center Receptionists** whose telephone number is **308-0956**

O.N. 4/29/04 ORI NADAV
PATENT EXAMINER
TECHNOLOGY CENTER 2800

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